

<b>PCN Number:</b>	20150122000	<b>PCN Date:</b>	01/23/2015
<b>Title:</b>	LMX9838 Datasheet Changes including Product MIC Certification – Device Symbolization to include MIC Certification		
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process
<input type="checkbox"/>	Design	<input checked="" type="checkbox"/>	Datasheet
<input type="checkbox"/>	Test Site	<input checked="" type="checkbox"/>	Packing/Shipping/Labeling
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials
	<input type="checkbox"/>		Part number change
<input type="checkbox"/>		<input type="checkbox"/>	Assembly Materials
<input type="checkbox"/>		<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>		<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### PCN Details

#### Description of Change:

The LMX9838 datasheet will undergo updates including a change to reflect the recently obtained MIC Certification. Sections 8.3.4 and 11 have been updated to reflect this certification. Top-side Symbolization will accordingly be changed to reflect this MIC Certification Marking as shown below. No changes in testing, materials or manufacturing sites are associated with this MIC certification.

	From	To
<b>Device Symbol</b>		

#### Datasheet Changes:

##### 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision E (January 2014) to Revision F	Page
<ul style="list-style-type: none"> <li>Added Handling Rating table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section .....</li> </ul>	1
<ul style="list-style-type: none"> <li>Changed EN 301 489-17 v1.2.1 to EN 301 489-17 v2.2.1.....</li> </ul>	35

The datasheet number will be changing:

Device Family	Change From:	Change To:
LMX9838	SNOSAZ9E	<b>SNOSAZ9F</b>

These changes may be reviewed at the datasheet links provided.

The updated datasheet can be accessed by the following link:

<http://www.ti.com/product/lmx9838?keyMatch=lmx9838&tisearch=Search-EN>

#### Reason for Change:

To reflect recently obtained MIC certification.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

<b>Changes to product identification resulting from this PCN:</b>	
Device symbolization with MIC mark	
<b>Product Affected:</b>	
LMX9838SB/NOPB	LMX9838SBX/NOPB

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>